

---

# Thermal Resistances of Gaseous Gap for Conforming Rough Contacts

*M. Bahrami*  
*J. R. Culham*  
*M. M. Yovanovich*

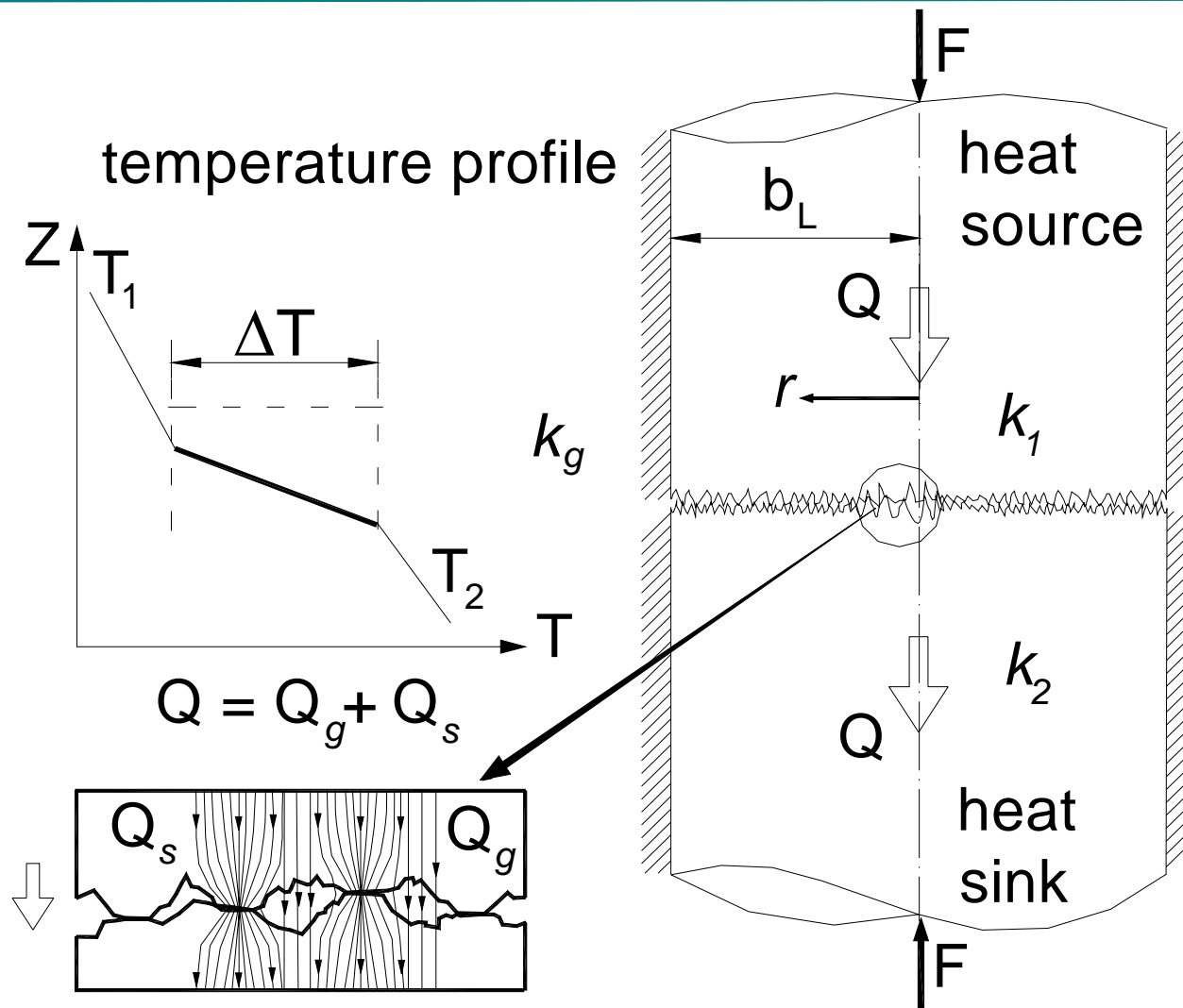
Department of Mechanical Engineering  
*Microelectronics Heat Transfer Laboratory*  
University of Waterloo  
Waterloo, ON, Canada

# CONTENTS

---

- introduction
- microcontacts thermal resistance
- gap thermal resistance
- present model
- present model vs. integral model
- parametric study
- comparison with experimental data
- summary and conclusions
- acknowledgements

# INTRODUCTION

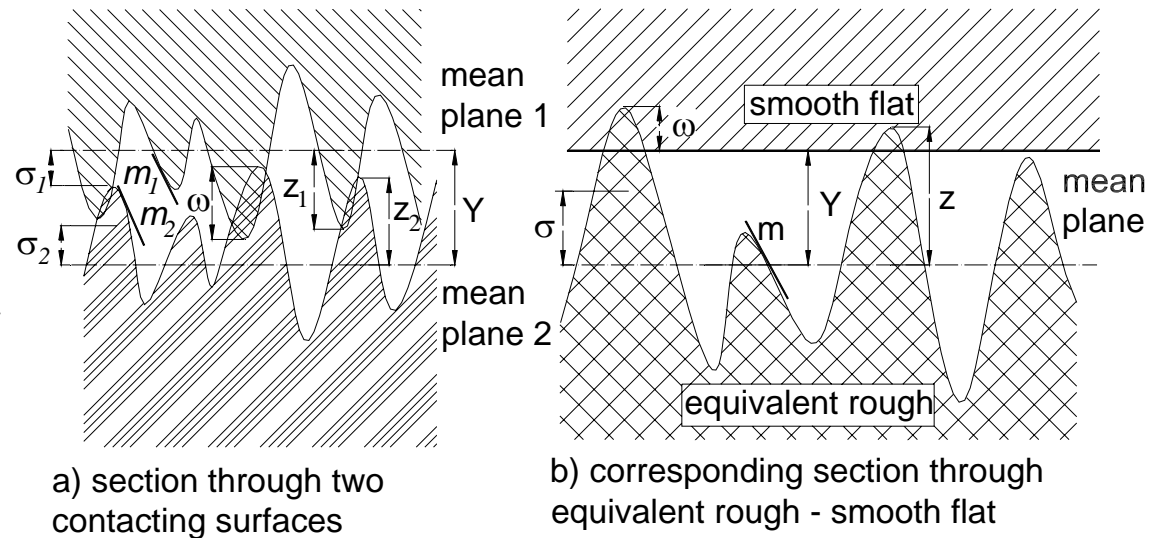


# MICROCONTACTS THERMAL RESISTANCE

Bahrami et al. (2003)

$$R_s = \frac{0.565c_1(\sigma/m)}{k_s F} \left(\frac{\sigma}{m}\right)^{c_2}$$

$$k_s = \frac{2k_1k_2}{k_1 + k_2}$$



$$\sigma = \sqrt{\sigma_1 + \sigma_2}$$

$$m = \sqrt{m_1 + m_2}$$

# CONDUCTION REGIMES IN GASES

Knudsen number  $Kn = \frac{\Lambda}{d}$

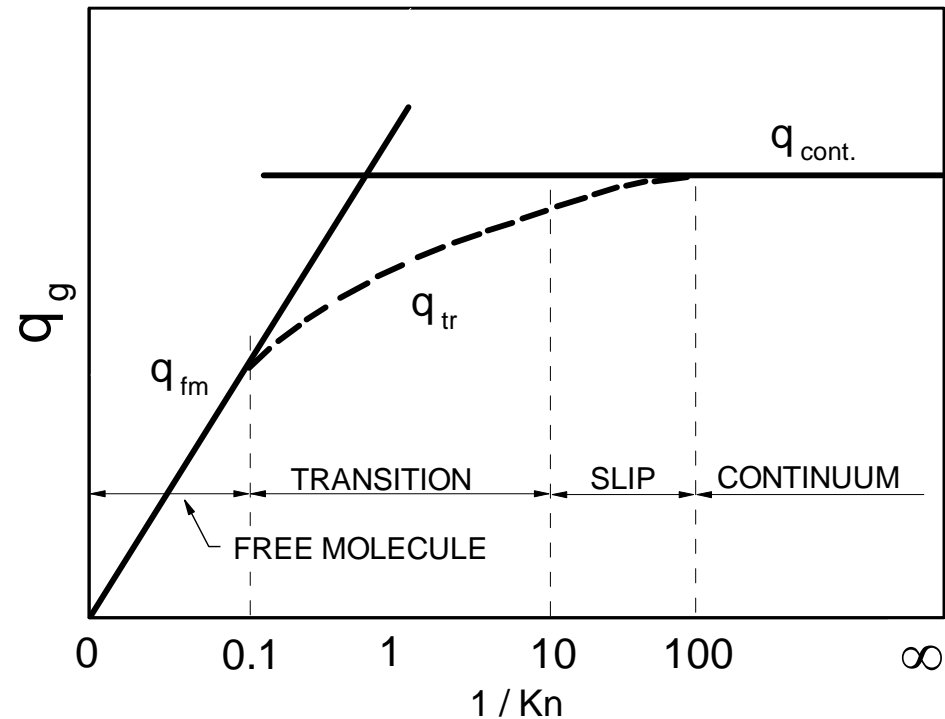
$\Lambda$ : molecular mean free path

$d$ : separation between two planes

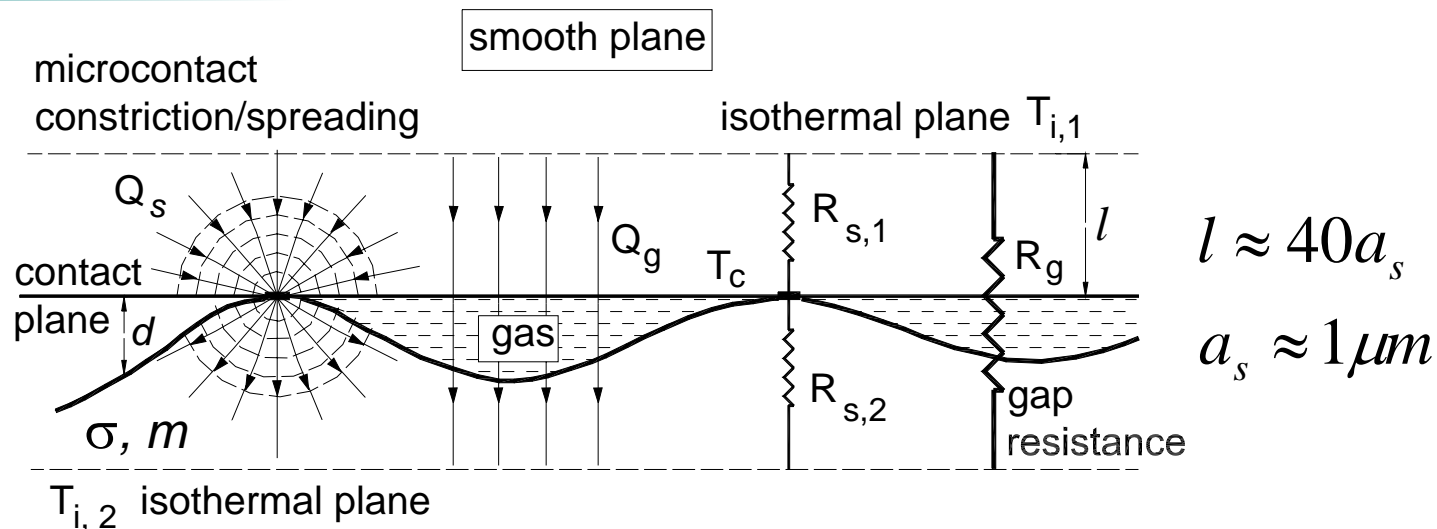
Kennard (1938) and Yovanovich (1982)

$$q_q = \frac{k_g}{d + M} (T_1 - T_2)$$

$$M = \left( \frac{2 - TAC_1}{TAC_1} + \frac{2 - TAC_2}{TAC_2} \right) \left( \frac{2\gamma}{1 + \gamma} \right) \frac{\Lambda}{Pr}$$



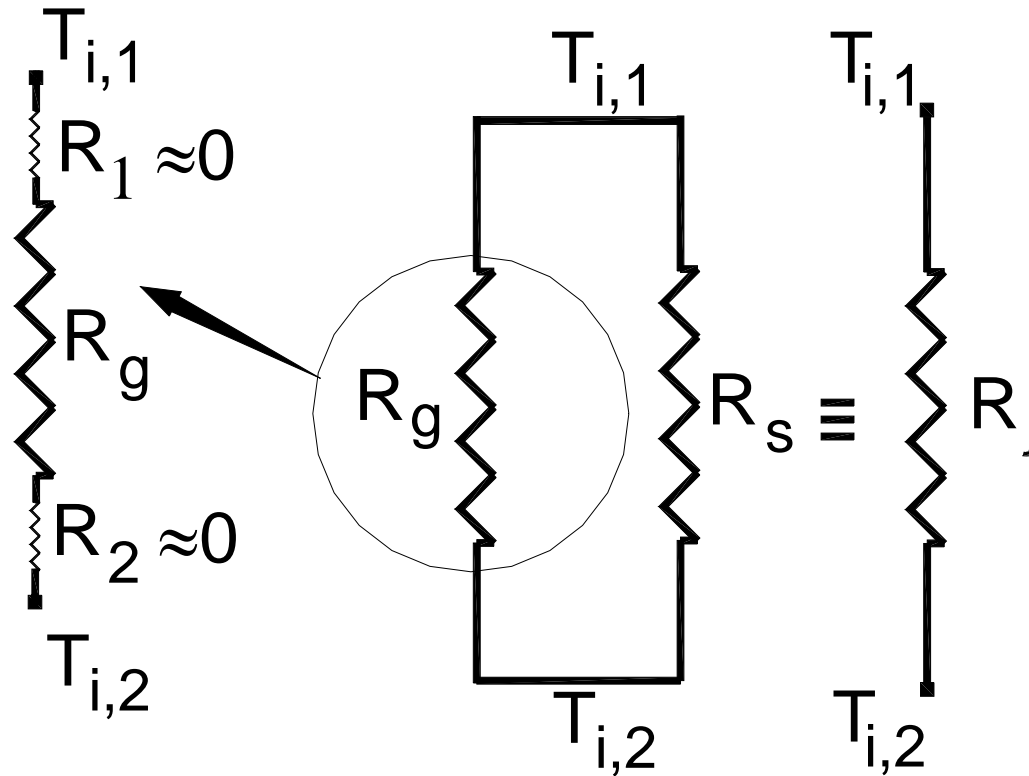
# PRESENT MODEL



equivalent rough surface

$$R_g = \underbrace{\frac{l}{k_{s,1}A_g} + \frac{l}{k_{s,2}A_g}}_{\approx 0} + \frac{d+M}{k_g A_g}, \quad \text{since } k_g / k_s \leq 0.01$$

# THERMAL RESISTANCE NETWORK



$$R_j = \left( \frac{1}{R_s} + \frac{1}{R_g} \right)^{-1}$$

# GAP THERMAL RESISTANCE

- Gaussian distribution

$$\phi(z) = \frac{1}{\sqrt{2\pi}\sigma} \exp\left(-\frac{z^2}{2\sigma^2}\right)$$

- assume  $A_g = A_a$

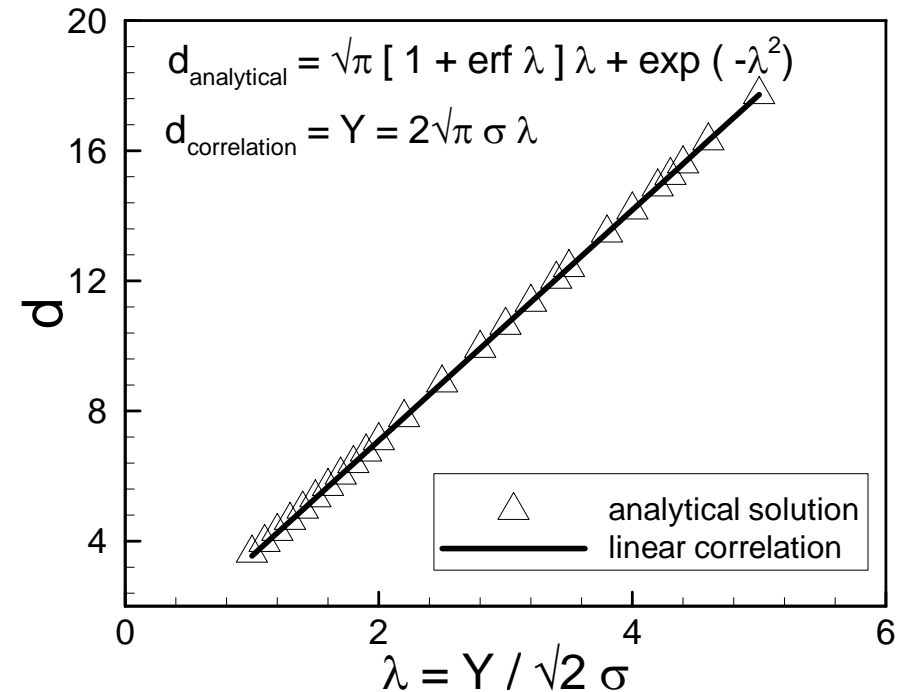
- effective separation,  $d$ :

$$d = \int_{-\infty}^Y (Y - z)\phi(z) dz$$

$$d = \frac{\sigma}{\sqrt{2\pi}} \left[ \sqrt{\pi} (1 + \operatorname{erf} \lambda) \lambda + \exp(-\lambda^2) \right]$$

- correlation for  $d$ :

$$d = Y$$





# GAP THERMAL RESISTANCE

- Cooper et al. (1969)  $\frac{P}{H_{mic}} = \frac{1}{2} \operatorname{erfc} \lambda$

- Song and Yovanovich (1988)

$$\frac{P}{H_{mic}} = \left( \frac{P}{H'} \right)^s \quad \text{where } H' = c_1 (1.62\sigma / m)^{c_2} \text{ and } s = \frac{1}{1 + 0.071c_2}$$

- assuming  $s = 1$   $\lambda = \frac{Y}{\sqrt{2}\sigma} = \operatorname{erfc}^{-1} \left( \frac{2P}{H'} \right)$

- a correlation for  $\operatorname{erfc}^{-1}(x)$  is proposed, for  $10^{-9} < x < 1.9$

- gap thermal resistance  $R_g = \frac{1}{k_g A_a} \left[ M + \underbrace{\sqrt{2}\sigma \operatorname{erfc}^{-1} \left( \frac{2P}{H'} \right)}_Y \right]$

# PRESENT MODEL VS INTEGRAL MODEL

Yovanovich et al. (1982)

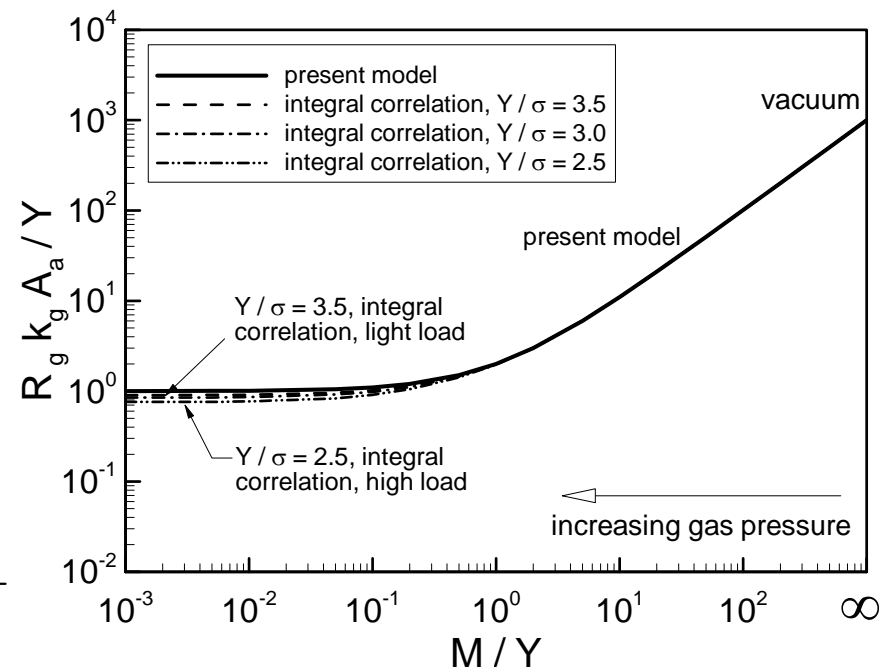
$$R_g = \frac{\sqrt{2\pi Y}}{A_a k_g \int_0^\infty \frac{\exp[-(Y/\sigma - t/\sigma)^2 / 2]}{(t/\sigma)/(Y/\sigma) + M/Y} d(t/\sigma)}$$

Song correlation (1988)

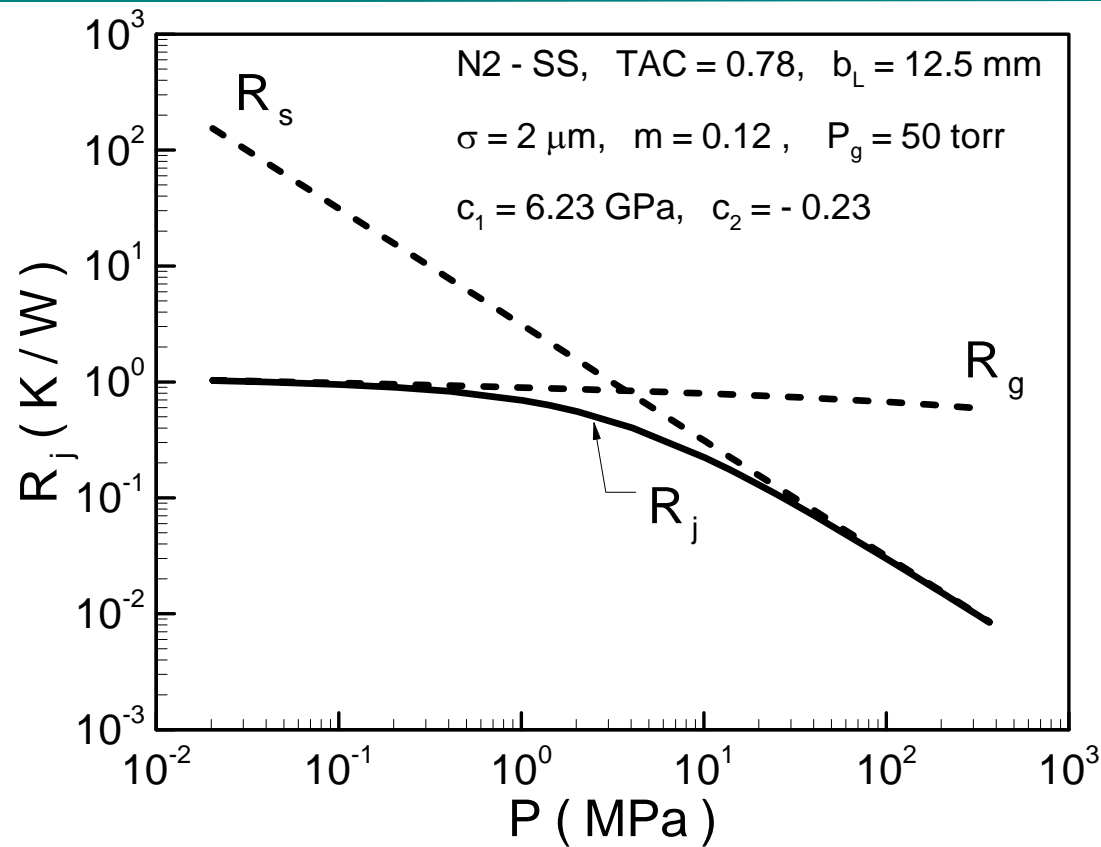
$$\frac{A_g k_g}{Y} R_g = 1 + \frac{0.304(\sigma/Y)}{(1+M/Y)} - \frac{2.29(\sigma/Y)^2}{(1+M/Y)^2} + \frac{M}{Y}$$

present model

$$\frac{A_g k_g}{Y} R_g = 1 + \frac{M}{Y}$$

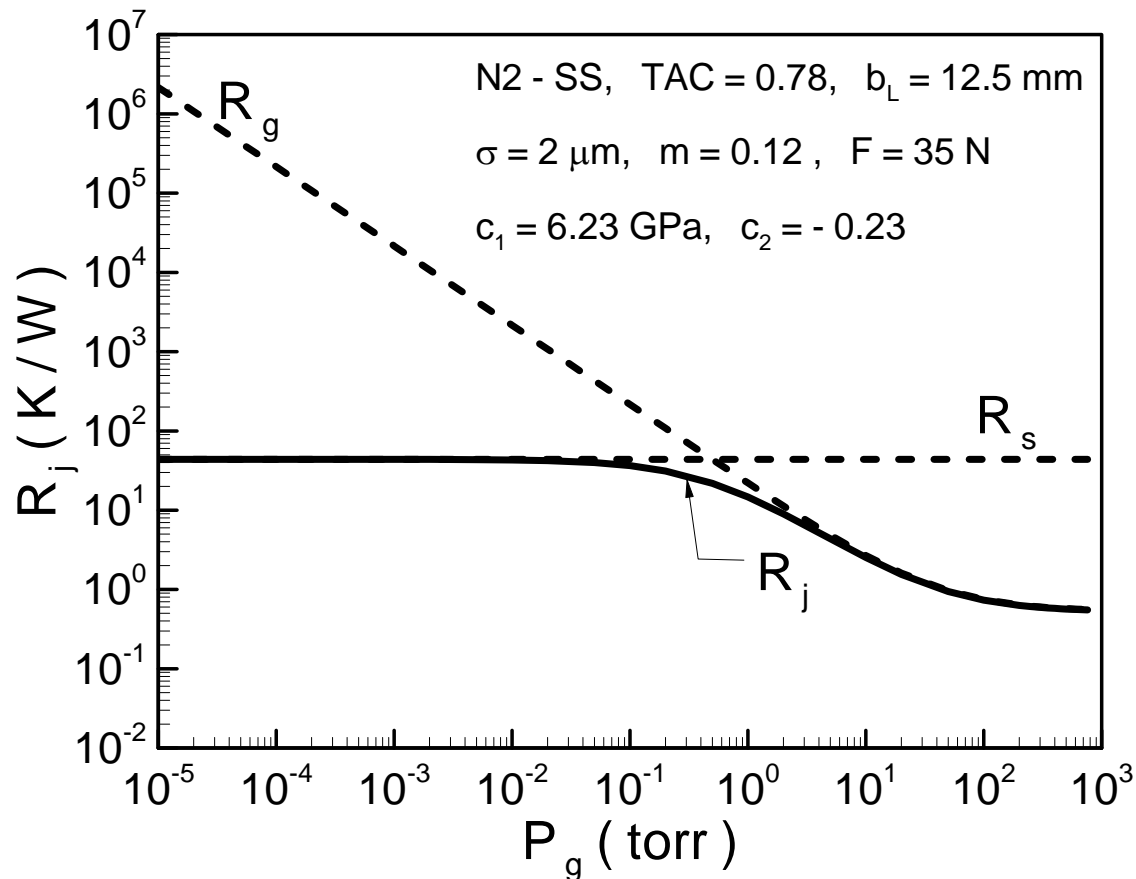


# EFFECT OF LOAD ON JOINT RESISTANCE



$$R_s = \frac{0.565 c_1 (\sigma / m)}{k_s F} \left( \frac{\sigma}{m} \right)^{c_2}$$

# EFFECT OF GAS PRESSURE ON JOINT RESISTANCE



$$\frac{A_g k_g}{Y} R_g = 1 + \frac{M}{Y}$$

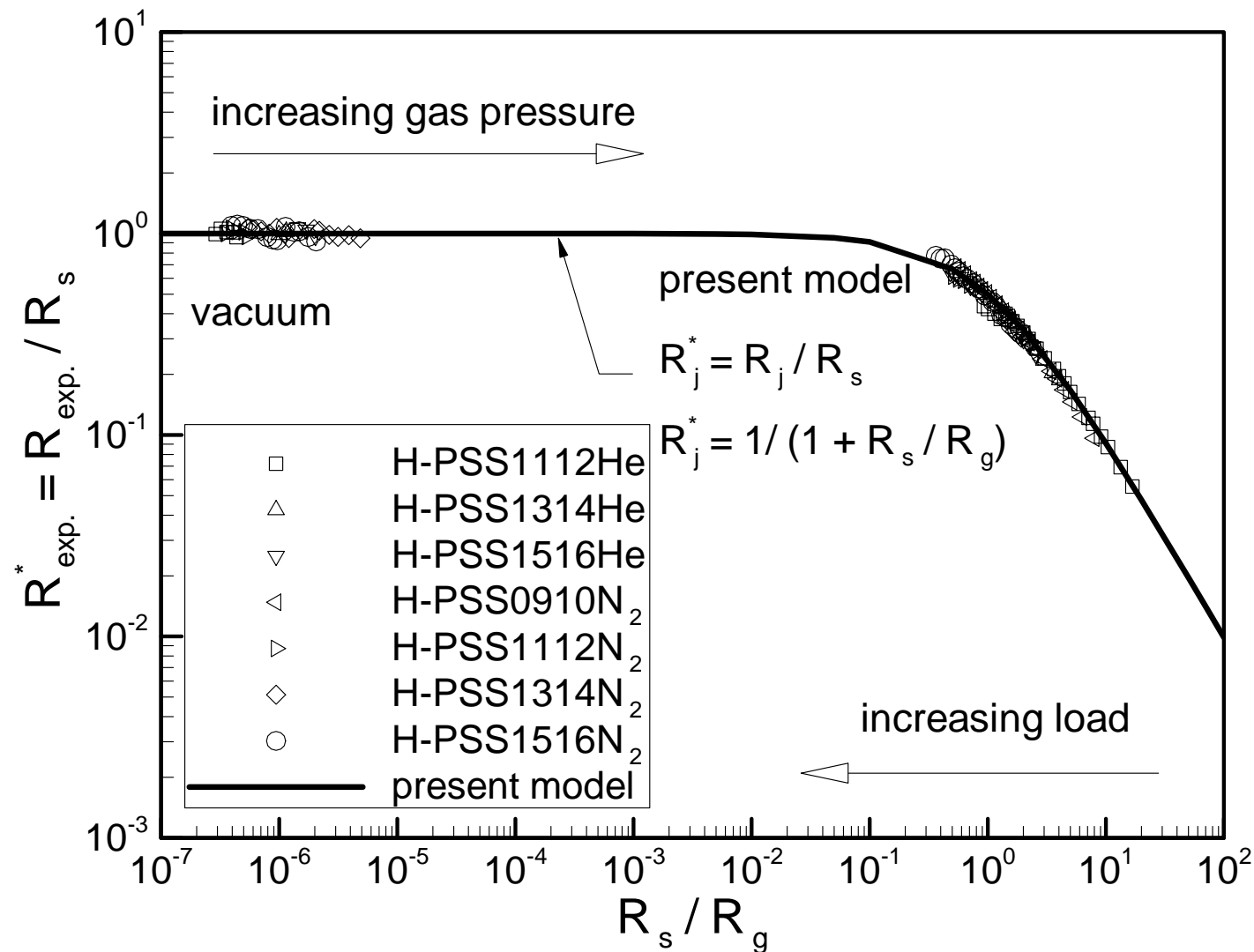
# EXPERIMENTAL DATA

- Hegazy (1985)
  - 160 data point
  - four sets of SS 304 joints in N<sub>2</sub> and He
- Song (1988)
  - 350 data points
  - seven sets of SS 304 and Ni 200 in Ar, He, and N<sub>2</sub>

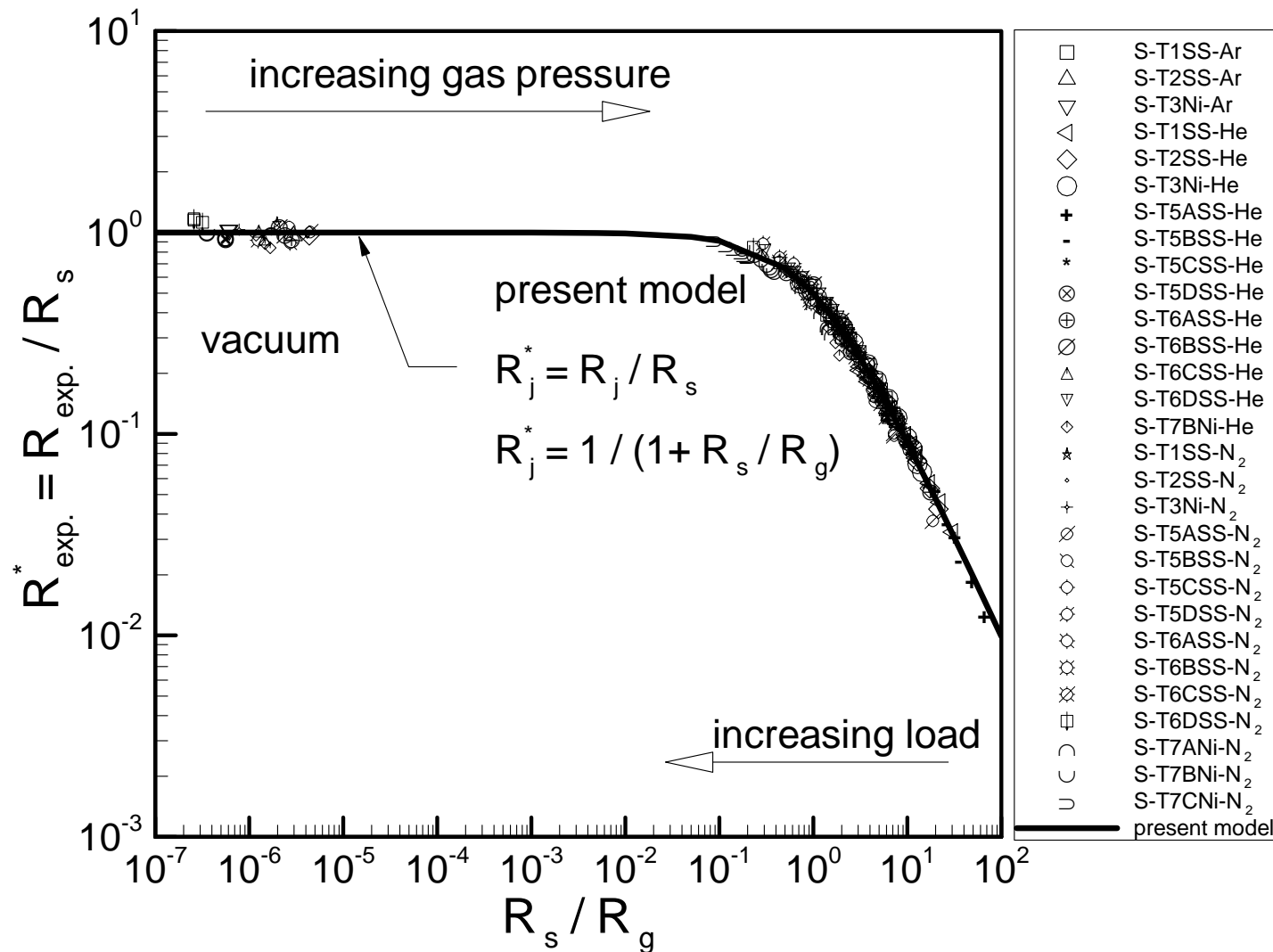
Parameter		
69.7	<i>F</i>	4357 <i>N</i>
0.14	<i>P</i>	8.8 <i>MPa</i>
19.2	<i>k<sub>s</sub></i>	72.5 <i>W/mK</i>
0.08	<i>m</i>	0.205
10 <sup>-5</sup>	<i>P<sub>g</sub></i>	760 <i>torr</i>
0.55	<i>TAC</i>	0.9
1.52		11.8 <i>m</i>

gas	<i>k<sub>g</sub></i>	Pr	TAC		o
□	<i>W/mK</i>	–	–	–	<i>nm</i>
Ar	0.018 4.05E-5T	0.67	0.90	1.67	66.6
He	0.147 3.24E-4T	0.67	0.55	1.67	186
N <sub>2</sub>	0.028 5.84E-5T	0.69	0.78	1.41	62.8

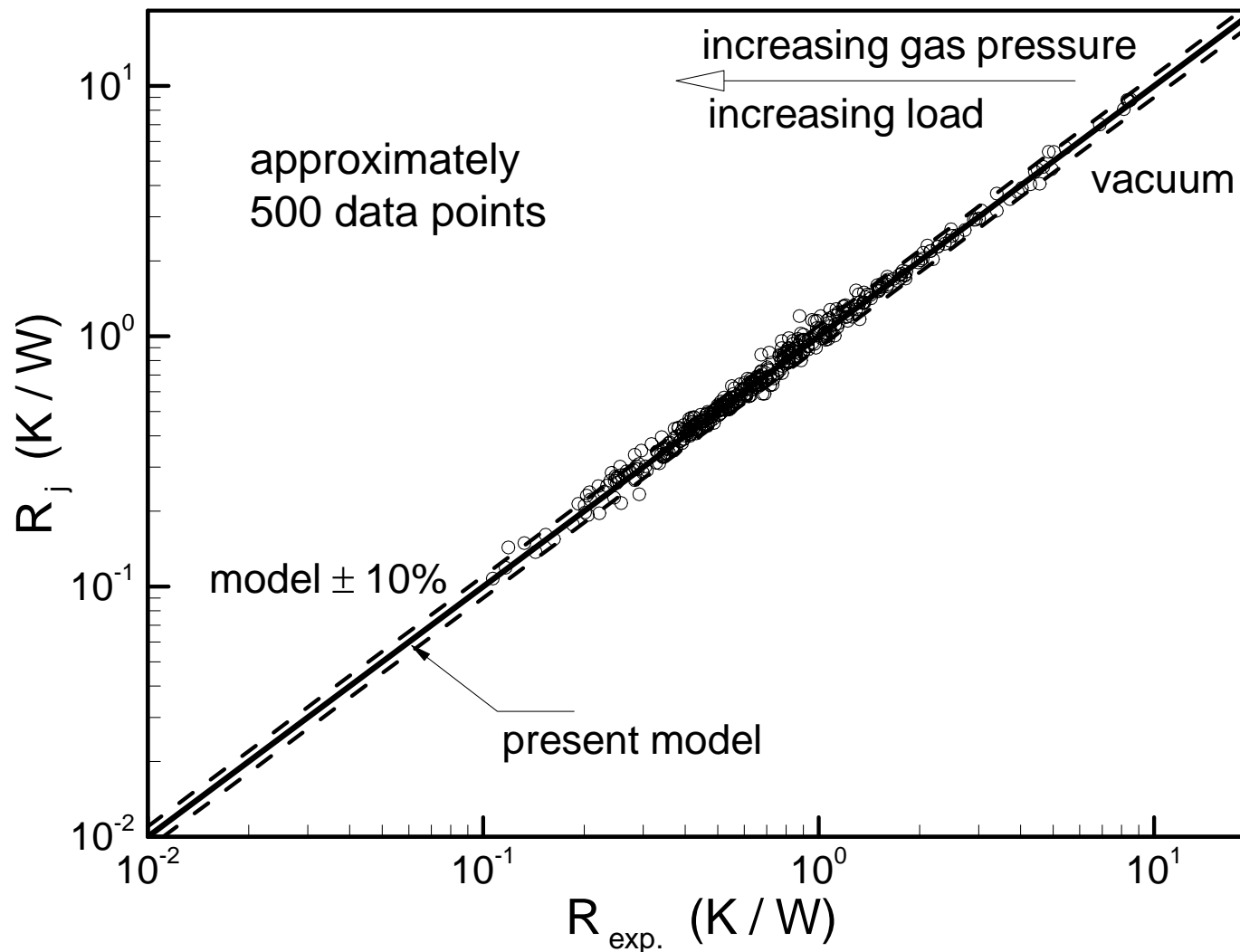
# COMPARISON WITH HEGAZY DATA



# COMPARISON WITH SONG DATA



# COMPARISON WITH ALL DATA





# SUMMARY AND CONCLUSIONS

---



- a compact model was developed for conforming rough joints in gaseous environment
- model covers four regimes of gas heat conduction, continuum, temperature-jump or slip, transition, and free molecular
- model accounts for gas and solid mechanical and thermal properties, gas pressure and temperature, surface roughness, and applied load
- for engineering applications,  $d = Y$

# SUMMARY AND CONCLUSIONS

---



- a correlation for inverse complementary error function was developed, with 2.8 percent max error over  $10^{-9} < x < 1.9$ .
- parametric studies showed
  - with constant gas pressure, at light loads  $R_g \ll R_s$ , thus most of the heat transfer occurs through gas. As load increases  $R_j$  decreases and  $R_s \ll R_g$
  - with constant load, at very low gas pressures  $R_g \gg R_s$ . As gas pressure increases  $R_g$  decreases and (at light loads) becomes controlling component of  $R_j$ .

# SUMMARY AND CONCLUSION

---

- comparison with Yovanovich et al. (1982) model showed
  - small difference for slip and free molecular regimes
  - larger difference for continuum regime (atmospheric pressure) at relatively high loads
- model was compared with more than 510 experimental data points of Hegazy (1985) and Song (1988):
  - SS 304 and nickel 200, three gases: argon, helium and nitrogen
  - data covered a wide range of surface characteristics, load, thermal and mechanical properties and gas pressure
  - model showed good agreement with RMS relative difference approximately 7.3 percent.

# ACKNOWLEDGEMENTS

---



- Natural Sciences and Engineering Research Council of Canada (NSERC)
- The Center for Microelectronics Assembly and Packaging (CMAP)